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15-A, 4.75-V to 14-V INPUT, NON-ISOLATED, WIDE-OUTPUT, DIGITAL POWERTRAIN™ MODULE

Check for Samples: PTD08A015W

FEATURES

- Up to 15-A Output Current
- 4.75-V to 14-V Input Voltage
- Programmable Wide-Output Voltage (0.7 V to 3.6 V)
- Efficiencies up to 96%
- Digital I/O
 - PWM signal
 - INHIBIT
 - Current limit flag (FAULT)
 - Sychronous Rectifier Enable (SRE)
- Analog I/O
 - Temperature
 - Output currrent
- Safety Agency Approvals: (Pending)
 - UL/IEC/CSA-C22.2 60950-1
- Operating Temperature: –40°C to 85°C

APPLICATIONS

 Digital Power Systems using UCD9XXX Digital Controllers



DESCRIPTION

The PTD08A015W is a high-performance 15-A rated, non-isolated digital PowerTrain module. This module is the power conversion section of a digital power system which incorporates TI's UCD7230 MOSFET driver IC. The PTD08A015W must be used in conjunction with a digital power controller such as the UCD9240 or UCD9110 family. The PTD08A015W receives control signals from the digital controller and provides parametric and status information back to the digital controller. Together, PowerTrain modules and a digital power controller form a sophisticated, robust, and easily configured power management solution.

Operating from an input voltage range of 4.75 V to 14 V, the PTD08A015W provides step-down power conversion to a wide range of output voltages from 0.7 V to 3.6 V. The wide input voltage range makes the PTD08A015W particularly suitable for advanced computing and server applications that utilize a loosely regulated 8-V, 9.6-V or 12-V intermediate distribution bus. Additionally, the wide input voltage range increases design flexibility by supporting operation with tightly regulated 5-V or 12-V intermediate bus architectures.

The module incorporates output over-current and temperature monitoring which protects against most load faults. Output current and module temperature signals are provided for the digital controller to permit user defined over-current and over-temperature warning and fault scerarios.

The module uses double-sided surface mount construction to provide a low profile and compact footprint. The PTD08A015W is constructed using through-hole pins and is lead (Pb) - free and RoHS compatible.

AA

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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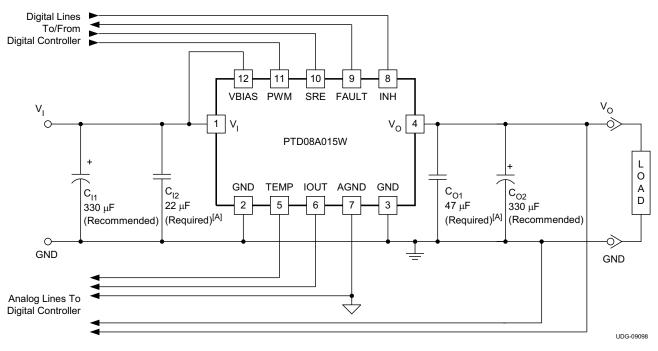




This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

Standard PTD08A015W Application



A. [A] C_{12} and C_{01} are optional when the operating frequency is greater than 500 kHz.



ORDERING INFORMATION

For the most current package and ordering information, see the Package Option Addendum at the end of this datasheet, or see the TI website at www.ti.com.

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ENVIRONMENTAL AND ABSOLUTE MAXIMUM RATINGS

(Voltages are with respect to GND)

				UNIT
VI	Input voltage		16	V
V_{B}	Bias voltage		16	V
T_A	Operating temperature range	Over V _I range	-40 to 85	
T _{wave}	Wave soldering temperature	Surface temperature of module body or pins for 5 seconds maximum	260	°C
T _{stg}	Storage temperature		-55 to 125 ⁽¹⁾	
	Mechanical shock	Per Mil-STD-883D, Method 2002.3, 1 msec, 1/2 sine, mounted	200	G
	Mechanical vibration	Mil-STD-883D, Method 2007.2, 20-2000 Hz	15	G
	Weight		3.9	grams
MTBF	Reliability	Per Telcordia SR-332, 50% stress, T _A = 40°C, ground benign	9.4	10 ⁶ Hr
	Flammability	Meets UL94V-O		

⁽¹⁾ The shipping tray or tape and reel cannot be used to bake parts at temperatures higher than 65°C.



ELECTRICAL CHARACTERISTICS

PTD08A015W

 $T_{A}=25^{\circ}C,\ F_{SW}=350kHz,\ V_{I}=12\ V,\ V_{O}=3.3\ V,\ V_{B}=V_{I},\ C_{I1}=330\ \mu\text{F},\ C_{I2}=22\ \mu\text{F}\ ceramic},\ C_{O1}=47\ \mu\text{F}\ ceramic},\ C_{O2}=330\ \mu\text{F},\ \text{and}\ I_{O}=I_{O(max)}\ (\text{unless otherwise stated})$

PARAMETER			PTD08A015W			UNIT		
							MAX	
Io	Output current	Over V _O range	er V _O range 25°C, natural convection 0				15	Α
VI	Input voltage range	Over I _O range			4.75		14 ⁽¹⁾	V
V _{OADJ}	Output voltage adjust range	Over I _O range			0.7 ⁽¹⁾		3.6	V
				V _O = 3.3 V		94%		
				V _O = 2.5 V		92%		
	Efficiency	$V_1 = V_B = 5 V$	$V_1 = V_B = 5 \text{ V}$ $V_O = 1.8$			89%		
η	Efficiency	$I_0 = 15 \text{ A},$ $f_S = 350 \text{ kHz}$		V _O = 1.5 V		87%		
				V _O = 1.2 V		85%		
				V _O = 1.0 V		82%		
V _{OPP}	V _O Ripple (peak-to-peak)	20-MHz bandwid	20-MHz bandwidth			20		mV_{PP}
V_B	Bias voltage				4.75		14	V
V _B	Bias voltage under voltage	V _B increasing				4.5	4.75	
UVLO	lockout			V _B decreasing	4.0	4.25	4.5	V
	Diag surrent	Inhibit (pin 8) to A	AGND	Standby		4		
I _B	Bias current		Switching		34		mA	
V _{IH}	High-level input voltage	CDE INIL 9 DW					5.5	.,
V_{IL}	Low-level input voltage	SKE, INH, & PW	SRE, INH, & PWM input levels				0.8	V
	DM/M input	Frequency range					1000	kHz
	PWM input	Pulse width limits	130			ns		
		Range	-40		125	°C		
	TEMP output	Accuracy, $-40^{\circ}\text{C} \le \text{T}_{\text{A}} \le 85^{\circ}\text{C}$					6	°C
	TEMP output	Slope				10		mV/°C
		Offset, T _A = 0°C		500		mV		
V_{OH}		High-level output	High-level output voltage, I _{FAULT} = 4mA					V
V_{OL}	FAULT output	Low-level output voltage, I _{FAULT} = 4mA				0	0.6	V
I _{LIM}		Overcurrent thres	Overcurrent threshold; Reset, followed by auto-recovery					Α
		Range	0.15		3.5	V		
	IOUT output	Gain				85	110	mV/A
	IOUT output	Offset, I _O = 0A, V _O = 1.2V				0.6	0.76	V
		Output Impedance	10	15	21	kΩ		
C	External input conscitones			330 ⁽²⁾		,,,,		
C _I	External input capacitance	Ceramic						μF
		Capacitance Value		Nonceramic		330 ⁽³⁾	5000 ⁽⁴⁾	
Co	External output capacitance			Ceramic	47 (3)		(3)	μF
		Equivalent series resistance (non-ceramic)						mΩ

- (1) The maximum input voltage is duty cycle limited to (V_O/(130ns × F_{SW})) or 14 V, whichever is less. The maximum allowable input voltage is a function of switching frequency.
- (2) A 22 μF ceramic input capacitor is required for proper operation. An additional 330 μF bulk capacitor rated for a minimum of 500mA rms of ripple current is recommended. When operating at frequencies > 500kHz the 22 μF ceramic capacitor is only recommended. Refer to the UCD9240 controller datasheet and user interface for application specific capacitor specifications.
- (3) A 47 μF ceramic output capacitor is required for basic operation. An additional 330 μF bulk capacitor is recommended for improved transient response. When operating at frequencies > 500kHz the 47 μF ceramic capacitor is only recommended. Refer to the UCD9240 controller datasheet and user interface for application specific capacitor specifications.
- (4) 5,000 μF is the calculated maximum output capacitance given a 1V/msec output voltage rise time. Additional capacitance or increasing the output voltage rise rate may trigger the overcurrent threshold at start-up. Refer to the UCD9240 controller datasheet and user interface for application specific capacitor specifications.
- (5) This is the minimum ESR for all non-ceramic output capacitance. Refer to the UCD9240 controller datasheet and user interface for application specific capacitor specifications.

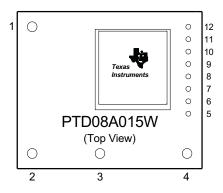
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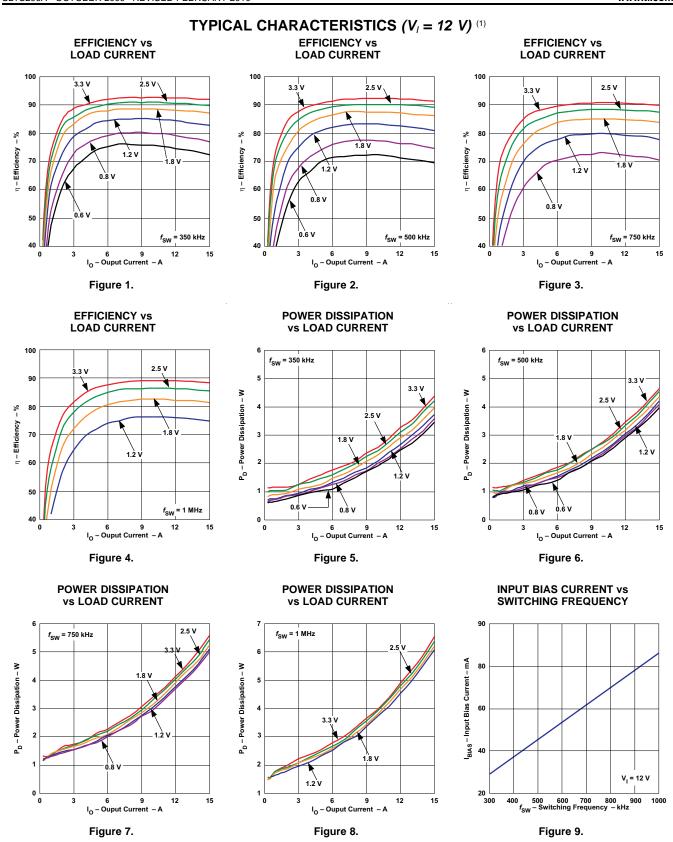


TERMINAL FUNCTIONS

TERMINAL		DECORPTION					
NAME	NO.	DESCRIPTION					
VI	1	The positive input voltage power node to the module, which is referenced to common GND.					
2							
GND	3	This is the common ground connection for the V_I and V_O power connections.					
Vo	4	The regulated positive power output with respect to GND.					
TEMP	5	Temperature sense output. The voltage level on this pin represents the temperature of the module.					
IOUT	6	Current sense output. The voltage level on this pin represents the average output current of the module.					
AGND	7	Analog ground return. It is the 0 V _{dc} reference for the control inputs.					
INH ⁽¹⁾	8	The inhibit pin is a negative logic input that is referenced to AGND. Applying a low-level signal to this pin disables the module and turns off the output voltage. A 10 k Ω pull-up to 3.3 V or 5 V is required if the INH signal is not used.					
FAULT	9	Current limit flag. The Fault signal is a 3.3 V digital output which is latched high after an over-current condition. The Fault is reset after two complete PWM cycles without an over-current condition (third rising edge of the PWM).					
SRE	10	Synchronous Rectifier Enable. This pin is a high impedance digital input. A 3.3 V or 5 V logic level signals is used to enable the synchronous rectifier switch. When this signal is high, the module will source and sink output current. When this signal is low, the module will only source current.					
PWM	11	This is the PWM input pin. It is a high impedance digital input that accepts 3.3 V or 5 V logic level signals up to 1 MHz.					
VBIAS	12	Bias voltage supply required to power internal circuitry. For optimal performance connect VBIAS to V _I .					

(1) Denotes negative logic: High = Normal operation, Low = Function active

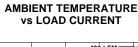




(1) The electrical characteristic data has been developed from actual products tested at 25°C. This data is considered typical for the converter.



TYPICAL CHARACTERISTICS ($V_i = 12 V$) Safe Operating Area (1)



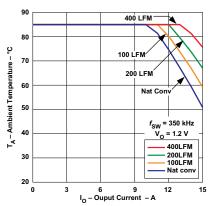


Figure 10.

AMBIENT TEMPERATURE vs LOAD CURRENT

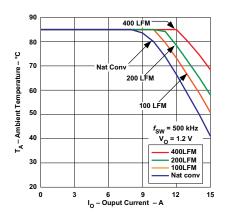


Figure 11.

AMBIENT TEMPERATURE vs LOAD CURRENT

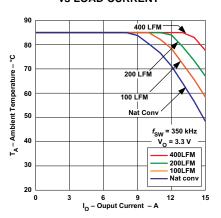


Figure 12.



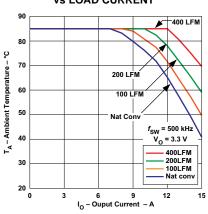
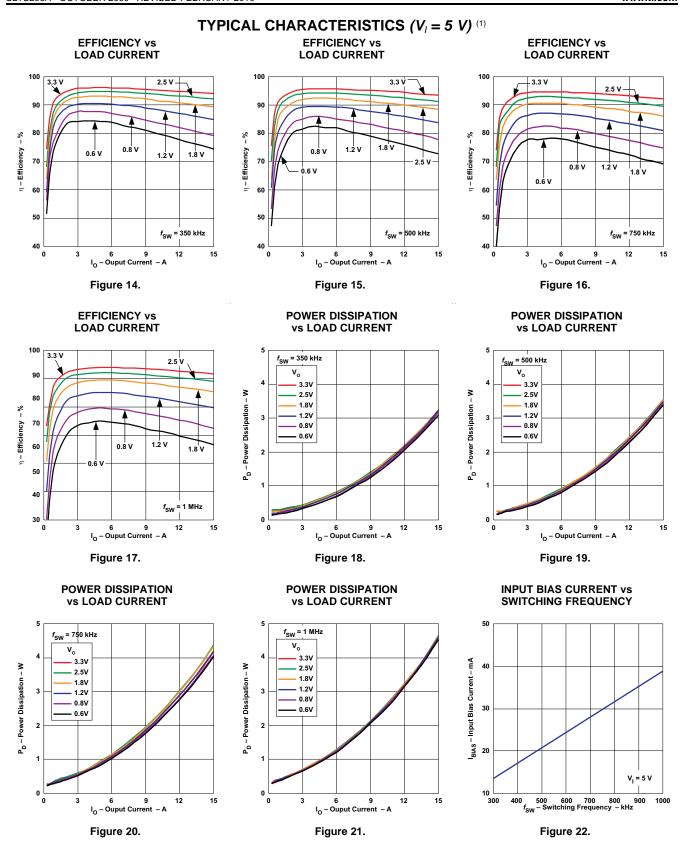


Figure 13.

⁽¹⁾ The temperature derating curves represent the conditions at which internal components are at or below the manufacturer's maximum operating temperatures. Derating limits apply to modules soldered directly to a 100 mm x 100 mm double-sided PCB with 2 oz. copper. Please refer to the mechanical specification for more information.





(1) The electrical characteristic data has been developed from actual products tested at 25°C. This data is considered typical for the converter.



TYPICAL CHARACTERISTICS ($V_l = 5 V$) Safe Operating Area (1)



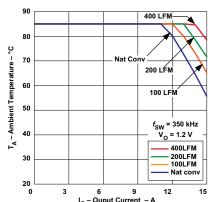


Figure 23.

AMBIENT TEMPERATURE vs LOAD CURRENT

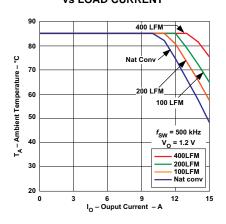


Figure 24.

AMBIENT TEMPERATURE vs LOAD CURRENT

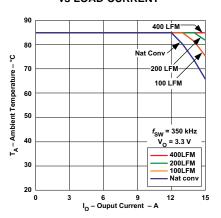


Figure 25.

AMBIENT TEMPERATURE vs LOAD CURRENT

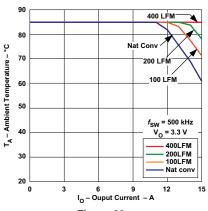


Figure 26.

⁽¹⁾ The temperature derating curves represent the conditions at which internal components are at or below the manufacturer's maximum operating temperatures. Derating limits apply to modules soldered directly to a 100 mm x 100 mm double-sided PCB with 2 oz. copper. Please refer to the mechanical specification for more information.



APPLICATION INFORMATION

Digital Power

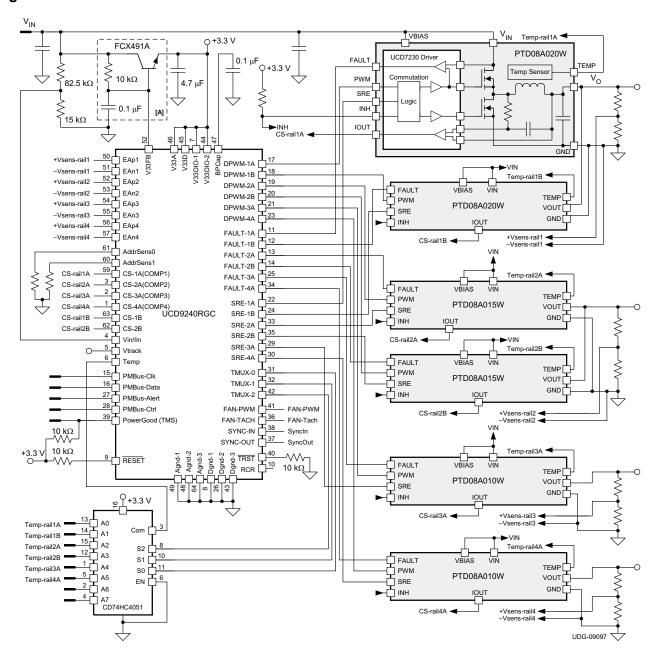


Figure 27. Typical Application Schematic

A. This discrete bias power circuit may be substituted with a low dropout regulator (LDO). For example, TPS715A33 can provide bias power to the UCD9240.

Figure 27 shows the UCD9240 power supply controller working in a system which requires the regulation of four independent power supplies. The loop for each power supply is created by the respective voltage outputs feeding into the Error ADC differential inputs, and completed by DPWM outputs feeding into the UCD7230 drivers which are shown on the PTD08A0x0W modules.



UCD9240 Graphical User Interface (GUI)

When using the UCD9240 digital controller along with digital PowerTrain modules to design a digital power system, several internal parameters of the modules are required to run the Fusion Digital Power Designer GUI. See the plant parameters below for the PTD08A015W digital PowerTrain modules.

Table 1. PTD08A015W Plant Parameters

PTD08A015W Plant Parameters						
L (μH) DCR (m Ω) Rds-on-hi (m Ω) Rds-on-lo (m Ω)						
0.90	2.2	3.6	3.6			

Internal output capacitance is present on the digital PowerTrain modules themselves. When using the GUI interface this capacitance information must be included along with any additional external capacitance. See the capacitor parameters below for the PTD08A015W digital PowerTrain modules.

Table 2. PTD08A015W Capacitor Parameters

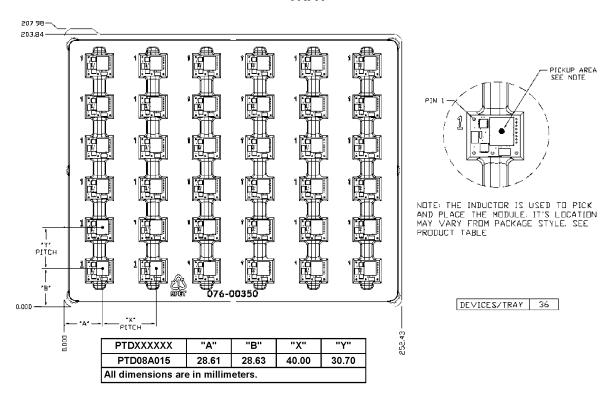
PTD08A015W Capacitor Parameters						
C (μ F) ESR ($m\Omega$) ESL (n H) Quantity						
47	1.5	2.5	1			

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TRAY



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PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
						(4)	(5)		
PTD08A015WAD	Active	Production	Through-Hole Module (EGS) 12	36 TIW TRAY	In-Work	SN	Level-1-235C-UNLIM/ Level-3-260C-168HRS	-40 to 85	
PTD08A015WAD.B	Active	Production	Through-Hole Module (EGS) 12	36 TIW TRAY	In-Work	SN	Level-1-235C-UNLIM/ Level-3-260C-168HRS	-40 to 85	

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

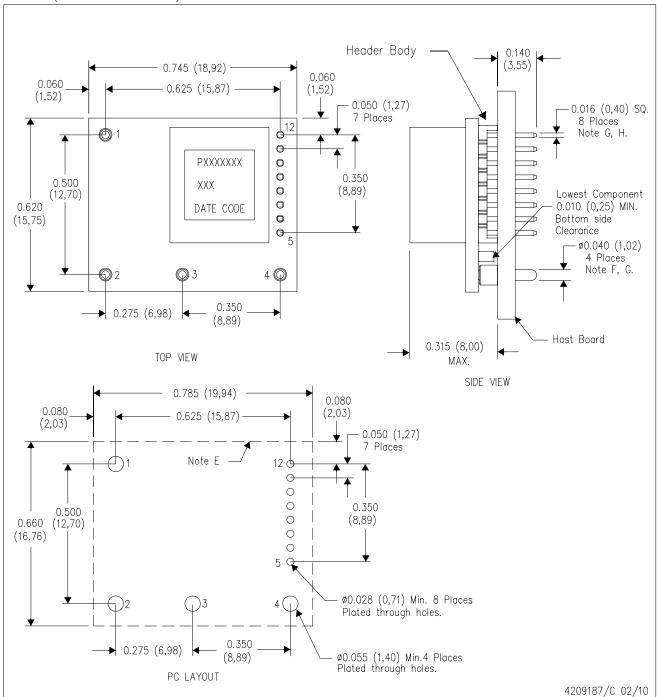
⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

EGS (R-PDSS-T12)

DOUBLE SIDED MODULE



NOTES:

- A. All linear dimensions are in inches (mm).
- B. This drawing is subject to change without notice.
- C. 2 place decimals are ± 0.030 (± 0.76 mm).
- D. 3 place decimals are ± 0.010 (± 0.25 mm).
- E. Recommended keep out area for user components.
- F. Pins are 0.040" (1,02) diameter with 0.070" (1,78) diameter standoff shoulder.
- G. Header pins are 0.016 (0,40) SQ.
- H. All pins: Material Copper Alloy

Finish - Tin (100%) over Nickel plate



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